





Methodology, tools and perspectives to achieve neural networks fast deployment on STM32: Image classifier case study

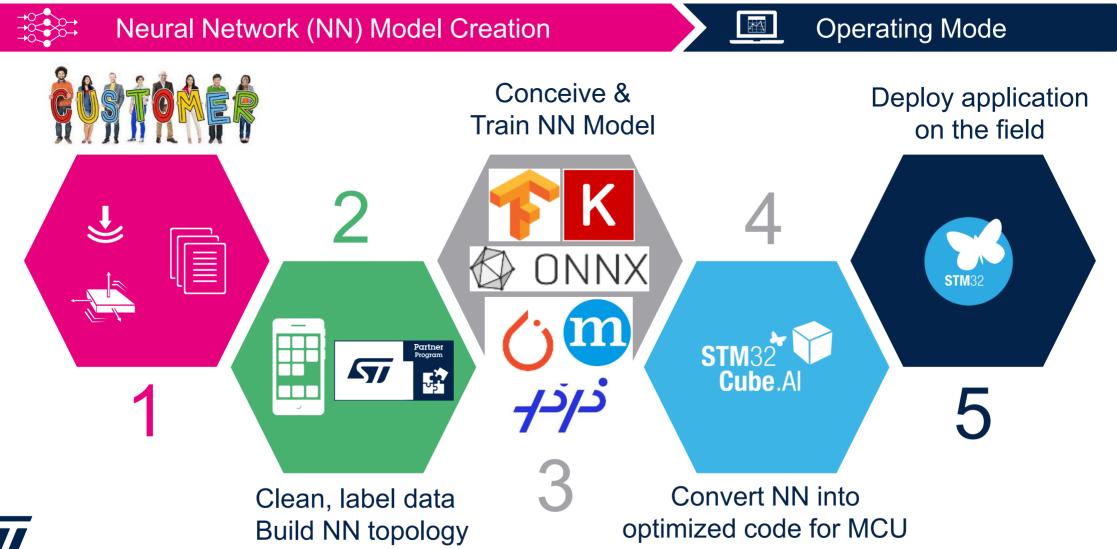
using Nucleo IoT node

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Key steps for Supervised Deep Learning



Capture data

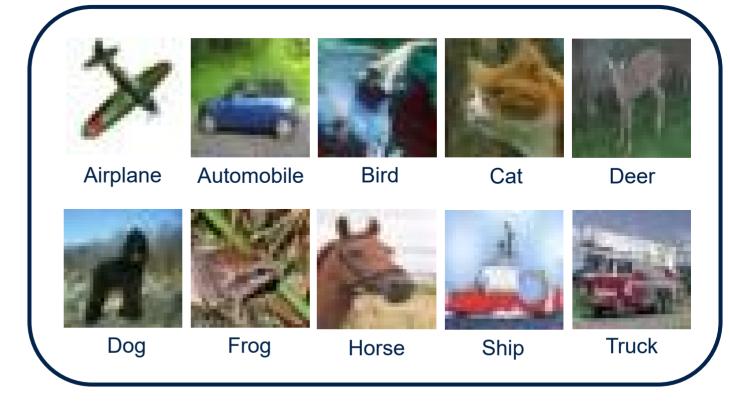


CIFAR-10 dataset

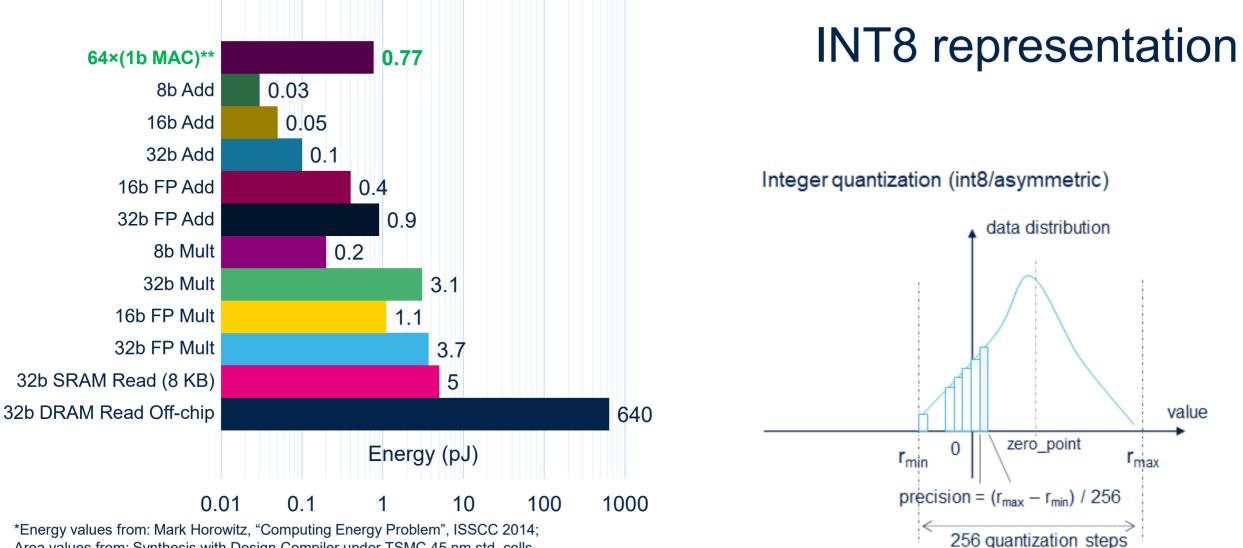
- CIFAR-10 is a labeled subset of a 80 million tiny images dataset
- 60,000 8-bit color images

Build NN topology

- 50,000 training images
- 10,000 test images
- 32x32 pixel images
- 10 classes each with 6,000 images





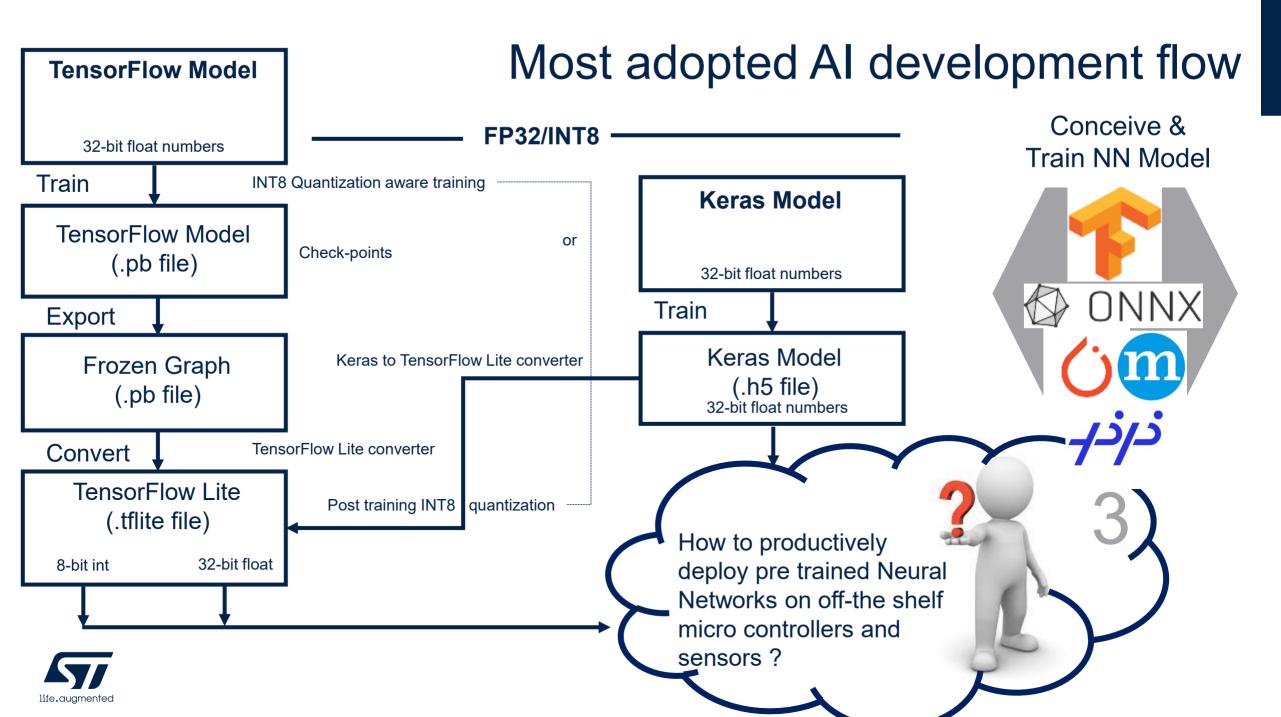


Area values from: Synthesis with Design Compiler under TSMC 45 nm std cells

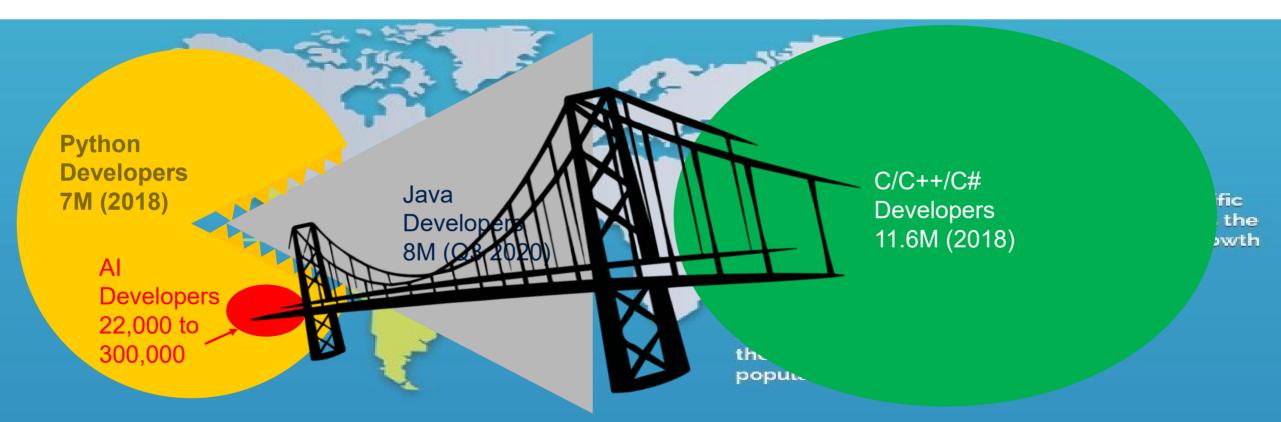
**Agrawal et al., "Xcel-RAM: Accelerating Binary Neural Networks in High-Throughput SRAM Compute Arrays", 2018

$$r = (q - zero_point) \times scale$$
 $q = \frac{r}{scale} + zero_point$



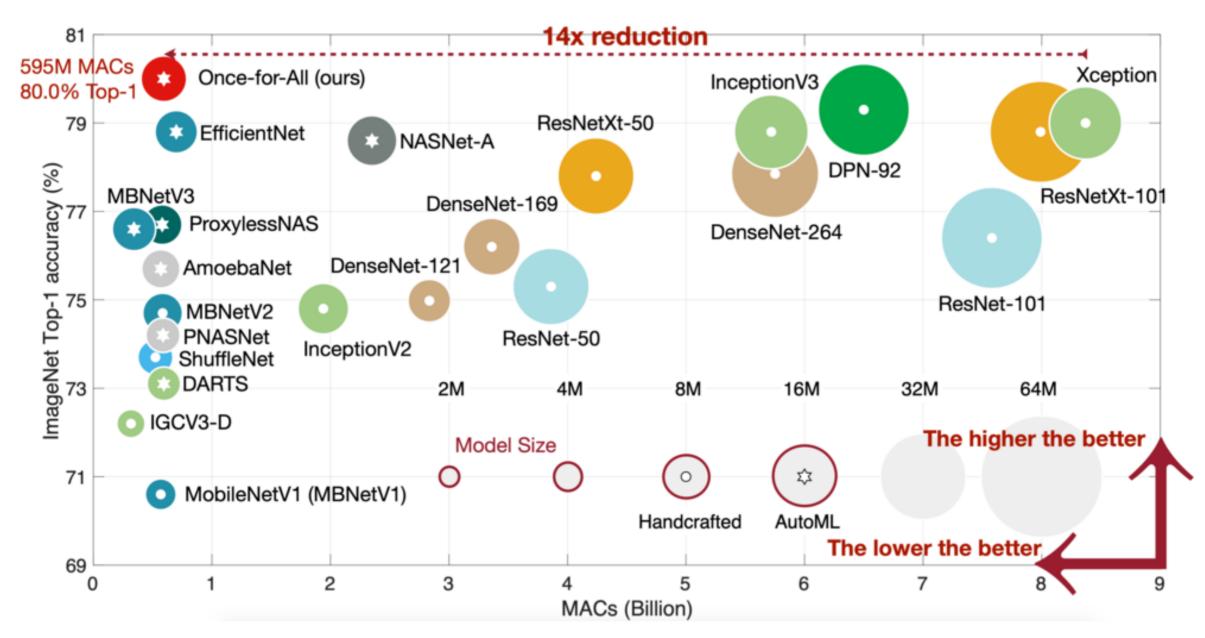


How to bridge the AI and embedded communities?





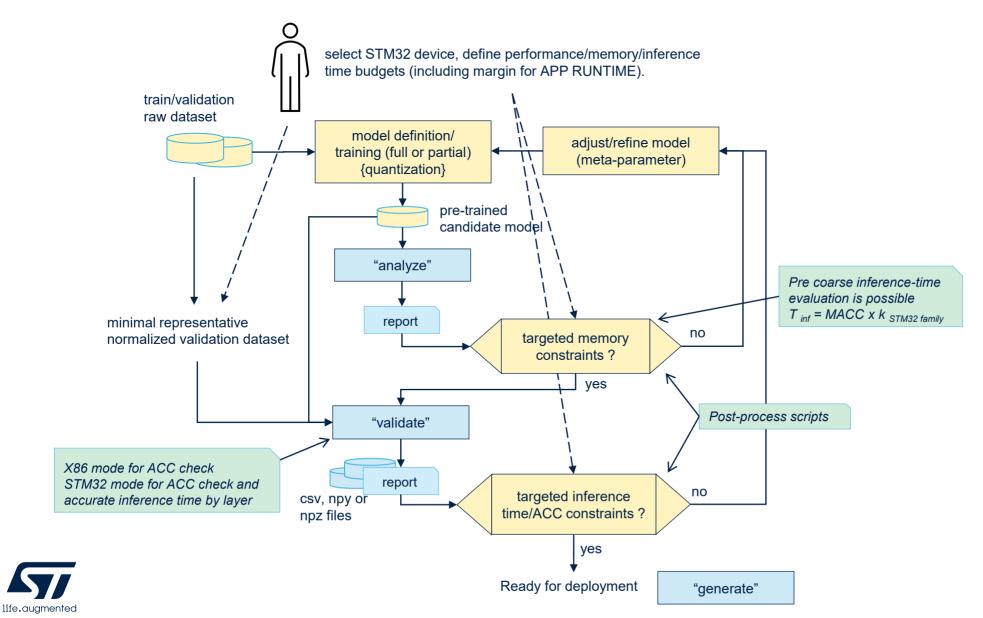
Global Developer Population and Demographic Study 2019, Volume 1 © 2019 Evans Data Corp



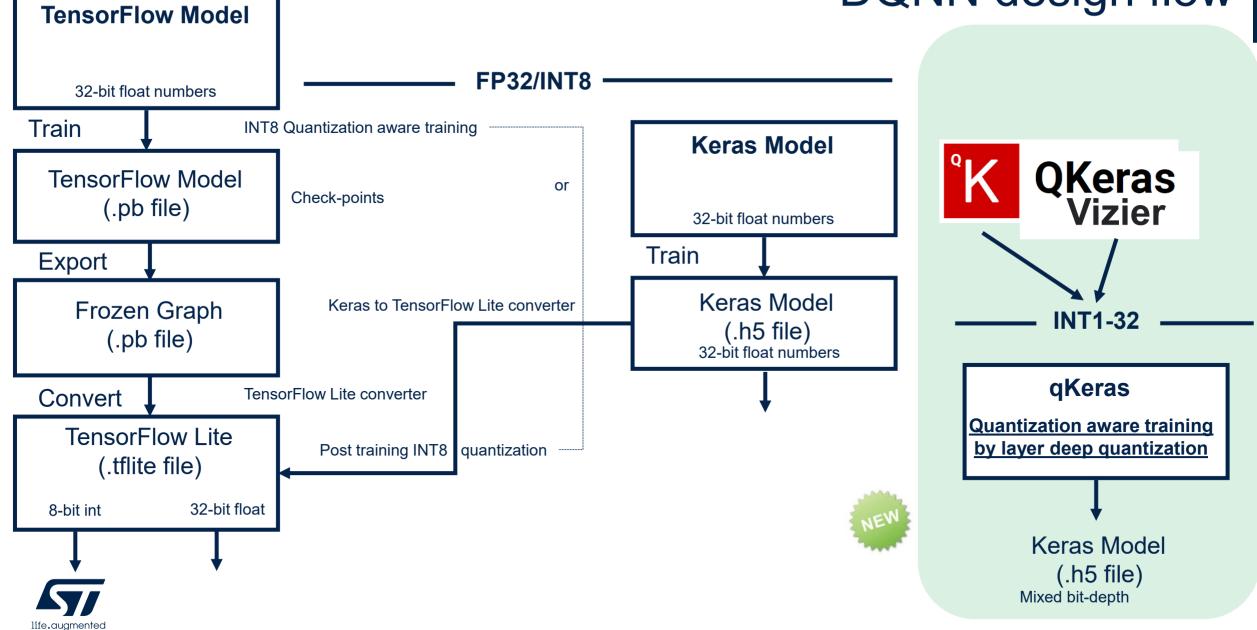


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NAS flow to support MCU deployability



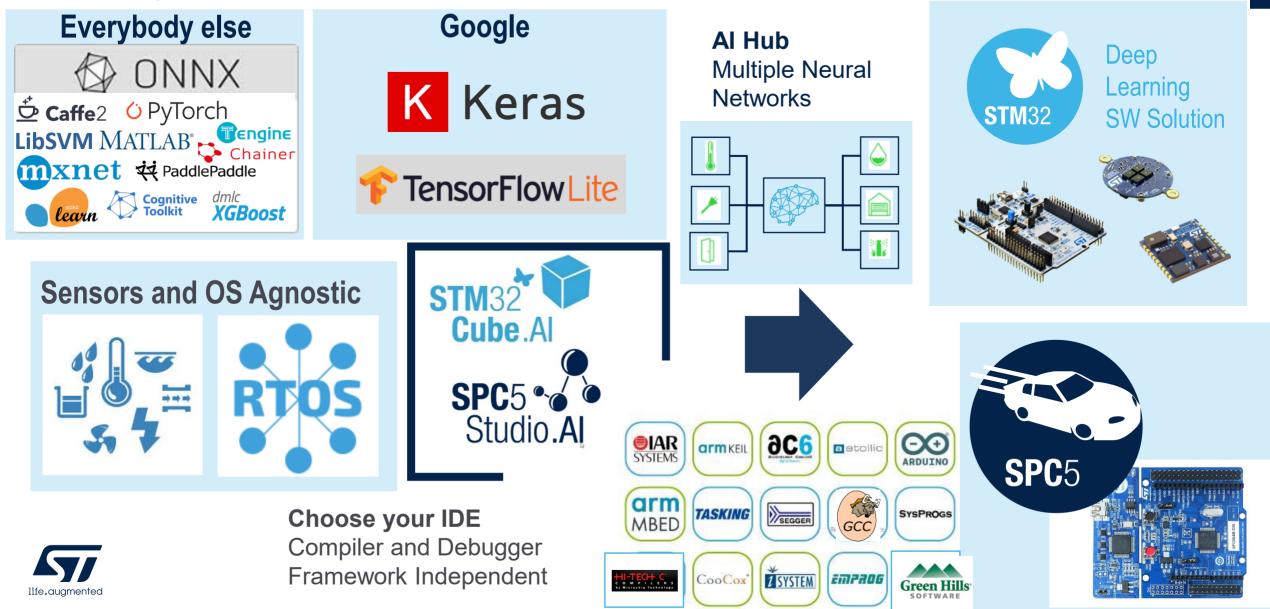
DQNN design flow



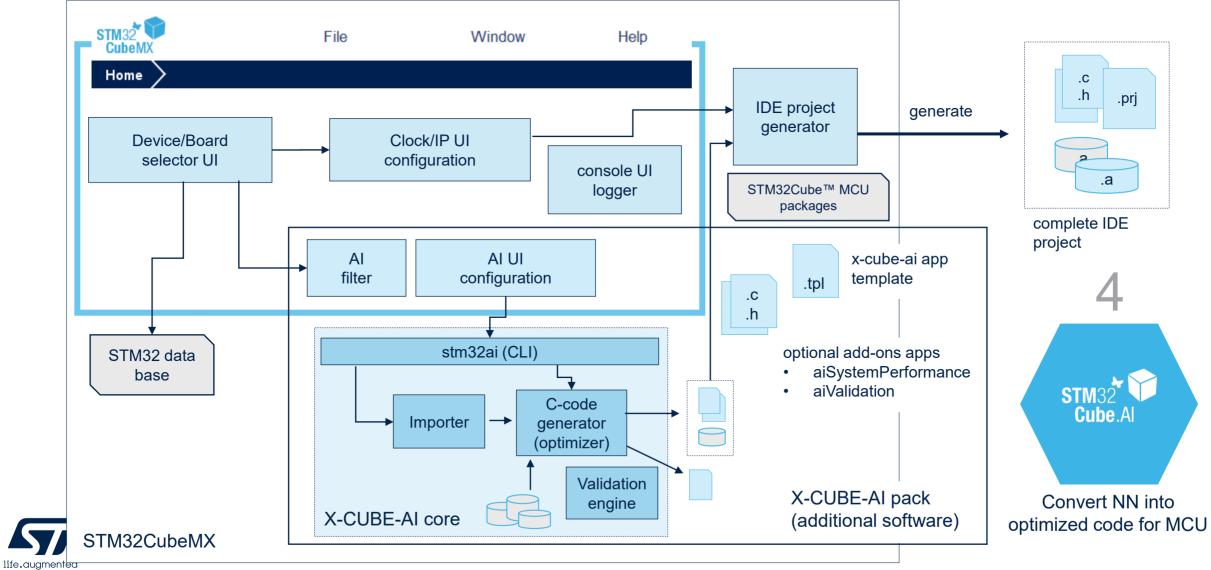
Interoperability

Pre-trained Neural Network models Deep Learning framework dependent

Founding requirements

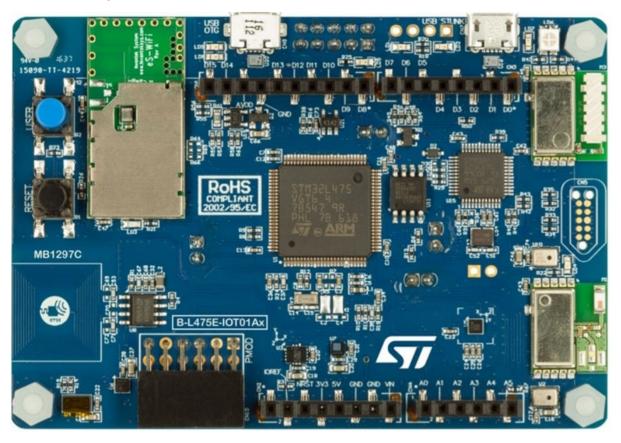


X-CUBE-AI package a STM32CubeMX additional sw



Deploy application on the field







STM32L4 Discovery kit IoT node

- Arm® Cortex®-M4 core with 1 Mbyte of Flash memory and 128 Kbytes
- 64-Mbit Quad-SPI Flash memory
- Bluetooth® V4.1 module
- Sub-GHz (868 MHz or 915 MHz) low-powerprogrammable RF module
- 802.11 b/g/n compliant Wi-Fi® module
- Dynamic NFC tag based on M24SR with its printed NFC antenna
- 2 digital omnidirectional microphones
- Capacitive digital sensor for relative humidity and temperature
- High-performance 3-axis magnetometer
- 3D accelerometer and 3D gyroscope
- 260-1260 hPa absolute digital output barometer
- Time-of-Flight and gesture-detection sensor



Thank you

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